

## JEAN-151-SN100C-T3

Rev: 20.10

Date	2021.08.18
Language	English
SDS	950632



## SUMMARY

Pb-free - Halide-free - Premium latest technology No-Clean solder paste

PASTE	JEAN-151-SN100C-T3
<b>PROCESS</b>	
No-Clean process	9
Post-solder cleaning	9

INDUSTRY APPLICATION	
Standard electronics	8
Industrial electronics	9
Hi-Rel electronics (automotive)	9

PROCESS CAPABILITY	
Squeegee	9
ProFlow	TBD
Pb-free Profile Air, short	9
Pb-free Profile Air, long	8
Pb-free process N2	9
Vapor phase process	7
Shiny joint appearance	9
Cosmetic cleanliness	8
ICCT compatible	N/A
Conformal coating	N/A

Legend	
<i>Epecially made for this purpose</i>	9 - 10
<i>Generally qualified for this purpose</i>	7 - 8
<i>Generally usable, but not the best choice</i>	5 - 6
<i>Generally not usable for this purpose</i>	3 - 4
<i>Wrong choice</i>	1 - 2

Check material compatibility with every process change!

Industrial chemical product.

Read MSDS before use.

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CLASSIFICATION	
DIN-EN-ISO-9454-1: 2016	1122
IPC-J-STD-004-A: 2004	ROLO
IPC-J-STD-005: 1995 (Powder)	T3
Particle size	[µm] 25-45

PROPERTIES	
Flux code	JEAN-151
Alloy Code	SN100C
Alloy composition	Sn99.3Cu0.7NiGe
Liquidus	[°C] 227
Solidus	[°C] 227
Recommended peak temp.	[°C] 238-260
Acid number	[mg KOH/g] 123
Flux	[% w/w] 11.2
Residues	Colorless
Tackiness Malcom TK1	IPC-TM-650 2.4.44 [gf] @ 0h 33

TEST REPORTS	
IPC/ANSI-J-STD-005	Compliant
Certificate of Compliance	Website
RoHS Compliant	Available
Application Note	EN/DE
Copper Mirror	IPC-TM-650 2.3.32 Pass
Halides	IPC-TM-650 2.3.33 [Silver Chromate] Pass
Halide	IPC-TM-650 2.3.35.1 [Fluoride by Spot] Pass
Copper Corrosion	IPC-TM-650 2.6.15 Pass
SIR	IPC-TM-650 2.6.3.3 Pass
ECM	IPC-TM-650 2.6.14.1 Pass

PACKAGING AND STORAGE	
Packaging jar	PP [g] 500
Packaging cartridge	HDPE [g] 650
Packaging cartridge	HDPE [g] 1300
Packaging Cassette Pro-Flow	[g] 800
Minimum shelf-life in months	4-10 °C 12